FORM PTO-1595 1-31-92

#45285

1015 RI 1015	958827
1.1502 " 1018	Docket #1829
To the Honorable Commissioner of Patents and Trade	
	emarks. Flease record the attached original
documents or copy thereof.	2. Name and address of receiving party:
1. Name of conveying parties:	2. Name and address of receiving party.
1. Jae-Sung Kwak	
2. Byung-Hoon Moon	Anam Semiconductor, Inc.
2. Byung-noon Moon	280-8, 2ga, Sungsu-dong, Sungdong-gu
	Seoul, Korea 133-706
No additional conveying parties.	
3. Nature of Conveyance:	No additional receiving parties.
o. Hataro or conveyance.	The diameter in the second part of the second part
CORRECTIVE: To correct conveyance recorded on	
08/19/1999 at reel/frame 010179/0873.	
NOTE: Original assignment was torn in opening	•
mail when returned from Assignment Branch at	
USPTO. Copy enclosed along with original.	
Signature Execution Date(s): August 9, 1999	
 Korean patent application number 98/27292, w 	
US Patent Application number: 09/347,794, w	nich matured to
US Patent number: 6,225,379	
5. Name and address of party to whom	6. Total number of applications and patents
correspondence concerning documents should be	involved:
mailed:	
	1
Name: Jane E. Gennaro	
	7. Total Fee (37 CFR 3,41) \$ 40.00
National Starch and Chemical Co.	7. Total Fee (57 51 K 5,4-1)
10 Finderne Avenue	Authorized to be charged to deposit account
Bridgewater, New Jersey	
ZIP: 08807	8. Deposit Account Number:
	14-0455
2. Otatement and Signature	
9. Statement and Signature To the best of my knowledge and belief, the foregoing information is true and correct and any attached	
copy is a true copy of the original document.	
1 1/2	
Jane E. Gennaro	Junero 01 Nav. 01
Sand L. Sommer	punano
Name of Person Signing Signature	Date
1	remarkant attachments and document:
Total number of pages including cover sheet, attachments, and document:	

01/23/2002 GTOW11 00000292 140455 09347794 40.00 CH 01 FC:581

PATENT REEL: 012475 FRAME: 0928

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FORM PTO-1595 08-25-199	DEPARTMENT OF COMMERCE	
1-31-92	Patent and Trademark Office	
	ER SHEET	
101125069	Docket #1829	
documents or copy thereof.	addition is located to actualized original	
1. Name of conveying party(ies):	2. Name and address of receiving party(ies):	
Jae-Sung Kwak and Byung-Hoon Moon	Name: National Starch and Chemical Investment Holding Corporation	
	Internal Address:	
Additional names(s) of conveying party(ies attached? □Yes ☒ No		
3. Nature of Conveyance: 8-19-99 ⊠Assignment □Merger	Street Address: P. O. Box 7663 City Wilmington State Delaware ZIP 19803-7663	
☐Security Agreement ☐Change of Name ☐Other	Additional name(s) & address(es) attached? □Yes 図No	
Execution Date: August 9, 1999	Tes MAO	
4. Application number(s) or patent number(s):	The state of the s	
If this document is being filed		
the execution date of the application is:		
A. Patent Application No.(s)	B. Patent No.(s)	
09/347,794		
Additional numbers attached? □Yes ⊠No		
5. Name and address of party to whom correspondence concerning documents should be	6. Total number of applications and patents	
mailed:	1	
Name: Jane E. Gennaro		
Internal Address: National Starch and Chemical	7. Total Fee (37 CFR 3,41) \$_40.00	
Company Street Address: P.O. Box 6500	□Enclosed ⊠Authorized to be charged to deposit account	
City <u>Bridgewater</u> State <u>New Jersey</u> ZIP 08807-0500	8. Deposit Account Number:	
	No. 14-0455	
DO NOT USE THIS SPACE 40E		
9. Statement and Signature	to the marking in true and correct and any attached	

Total number of pages including cover sheet, attachments, and document: 3

To the best of my knowledge and belief, the foregoing information is true and correct and any attached

Signature

copy is a true copy of the original document.

Jane E. Gennaro

Name of Person Signing

August 17, 1999

Date

ASSIGNMENT

In consideration of good and valuable undersigned,	e consideration, the receipt of which is hereby acknowledged, the
(1) Jae-Sung Kwak	
(2) Byung-Hoon Moon	
HEREBY SELL(S), ASSIGN(S) AND TR	RANSFER(S) TO
 (2) Anam Semiconductor, Inc. (3) 280-8, 2ga, Sungsu-dong, Sungdor 	having a place of business at ng-gu, Seoul, Korea 133- 706
disclosed in the application for United S	ire right, title and interest in and to any and all improvements which are tates Letters Patent entitled FOR BONDING SEMICONDUCTOR CHIPS"
which application was: (a) Executed by the undersig	ned on <u>(5a)</u> Aug. 9, 1999
(b) filed on (5b)	
And assigned Serial No.	
right to all benefits under all internation for said improvements. It is hereby authorized and requested the when granted, to said Assignee, its assignee.	tes, renewals or continuations of said application and patents, and the all conventions for the protection of industrial property and applications at the Commissioner of Patents issue any and all of said Letters Patent, gns or its successors in interest or its designee.
Assignee, the undersigned will execu	reed that, when requested, without charge to but at the expense of said te all divisional, continuing, substitute, renewal, and reissue patent apers; and generally do everything possible which said Assignee shall and maintaining patent protection as provided herein.
DATE:	INVENTOR(S):
Aug. 9, 1999	Jae-Sung Kwak J S (Cusut
Aug. 9, 1999	Byung-Hoon Moon piors.
	•
WITNESSES:	Hwa

RECORDED: 01/15/2002

PATENT REEL: 012475 FRAME: 0930